

RQJ0202VGDQA

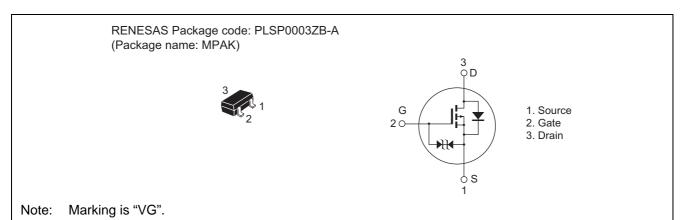
Silicon P Channel MOS FET Power Switching

REJ03G1318-0300 Rev.3.00 May 24, 2006

Features

- Low on-resistance $R_{DS(on)} = 83 \ m\Omega \ typ \ (V_{GS} = -4.5 \ V, \ I_D = -1.4 \ A)$
- Low drive current
- High speed switching
- 2.5 V gate drive

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

| | | | (14 20) |
|--|-----------------------------|-------------|----------|
| Item | Symbol | Ratings | Unit |
| Drain to source voltage | V _{DSS} | -20 | V |
| Gate to source voltage | V _{GSS} | +8 / -12 | V |
| Drain current | I _D | -2.7 | Α |
| Drain peak current | I _{D(pulse)} Note1 | -8.0 | Α |
| Body - drain diode reverse drain current | I _{DR} | -2.7 | Α |
| Channel dissipation | Pch Note2 | 0.8 | W |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. When using the glass epoxy board (FR-4: 40 x 40 x 1 mm)

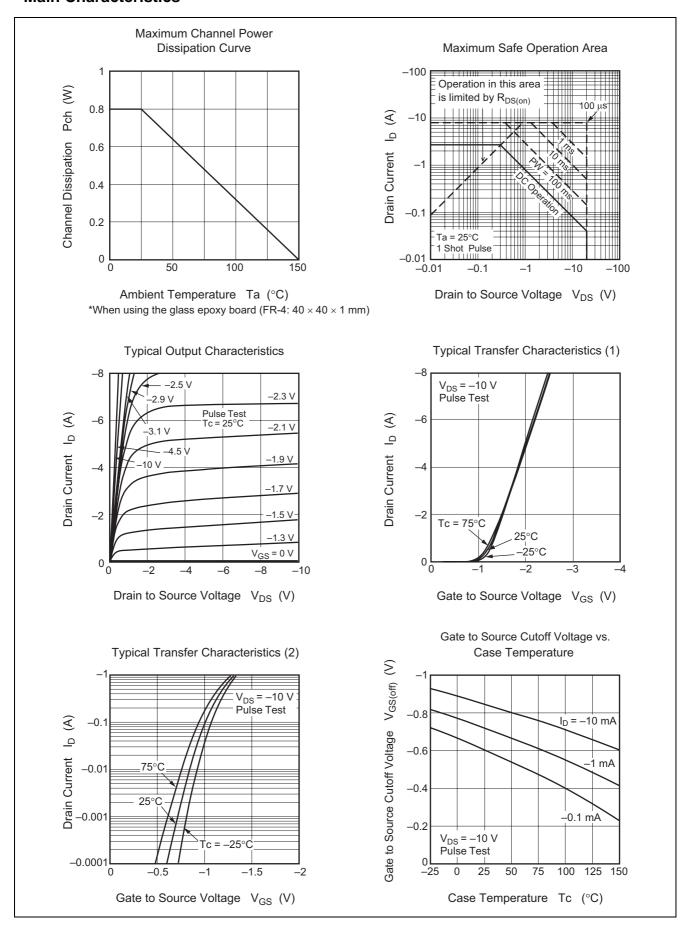
Electrical Characteristics

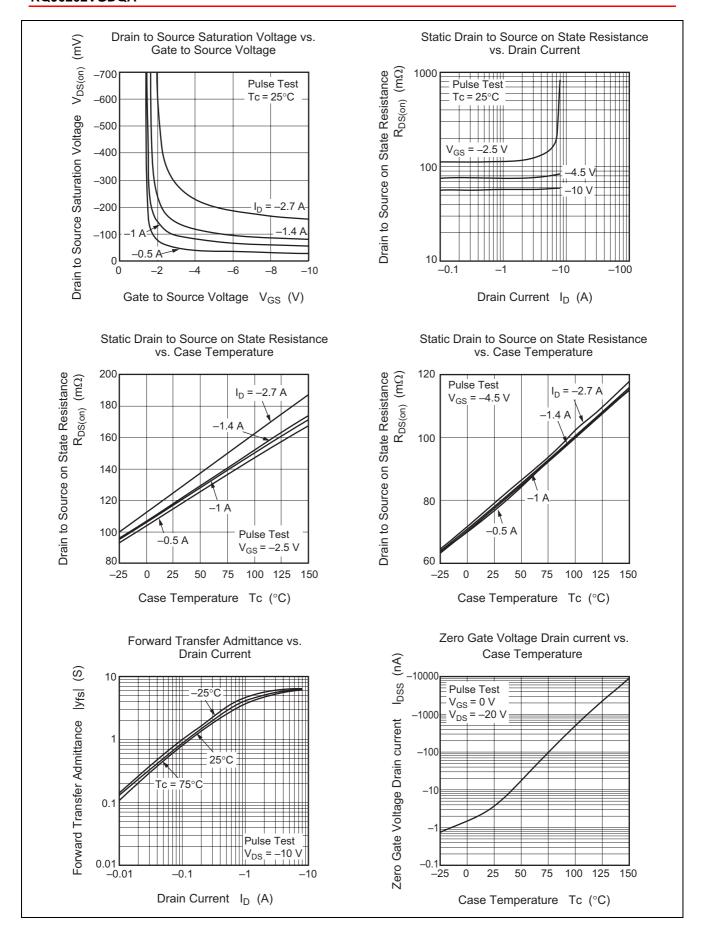
 $(Ta = 25^{\circ}C)$

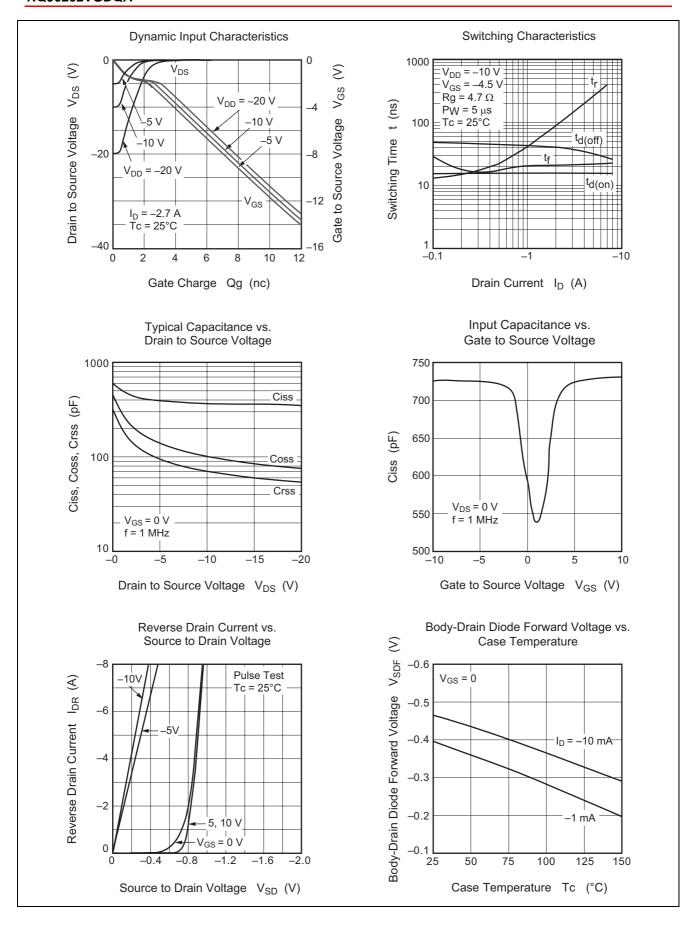
| Item | Symbol | Min | Тур | Max | Unit | Test conditions |
|-------------------------------------|---------------------|------|-------|------|------|--|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | -20 | _ | _ | V | $I_D = -10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | +8 | _ | | ٧ | $I_G = +100 \mu\text{A}, V_{DS} = 0$ |
| | $V_{(BR)GSS}$ | -12 | _ | 1 | > | $I_G = -100 \mu\text{A}, V_{DS} = 0$ |
| Gate to source leak current | I _{GSS} | _ | _ | +10 | μΑ | $V_{GS} = +6 \text{ V}, V_{DS} = 0$ |
| | I _{GSS} | _ | _ | -10 | μΑ | $V_{GS} = -10 \text{ V}, V_{DS} = 0$ |
| Drain to source leak current | I _{DSS} | _ | _ | -1 | μΑ | $V_{DS} = -20 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(off)}$ | -0.4 | _ | -1.4 | V | $V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$ |
| Drain to source on state resistance | R _{DS(on)} | _ | 83 | 105 | mΩ | $I_D = -1.4 \text{ A}, V_{GS} = -4.5 \text{ V}^{\text{Note3}}$ |
| | R _{DS(on)} | _ | 124 | 170 | mΩ | $I_D = -1.4 \text{ A}, V_{GS} = -2.5 \text{ V}^{\text{Note3}}$ |
| Forward transfer admittance | y _{fs} | 3 | 4.5 | _ | S | $I_D = -1.4 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note3}}$ |
| Input capacitance | Ciss | _ | 365 | _ | рF | V _{DS} = -10 V |
| Output capacitance | Coss | _ | 102 | _ | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | Crss | _ | 70 | _ | pF | f = 1 MHz |
| Turn - on delay time | t _{d(on)} | _ | 15 | _ | ns | $I_D = -1.4 \text{ A}$ |
| Rise time | t _r | _ | 57 | _ | ns | $V_{GS} = -4.5 \text{ V}$ |
| Turn - off delay time | t _{d(off)} | _ | 40 | _ | ns | $R_L = 7.1 \Omega$ |
| Fall time | t _f | _ | 21 | _ | ns | $Rg = 4.7 \Omega$ |
| Total gate charge | Qg | | 4.3 | | nC | V _{DD} = -10 V |
| Gate to source charge | Qgs | | 0.6 | | nC | $V_{GS} = -4.5 \text{ V}$ |
| Gate to drain charge | Qgd | _ | 1.7 | _ | nC | $I_D = -2.7 \text{ A}$ |
| Body - drain diode forward voltage | V_{DF} | _ | -0.85 | -1.1 | V | $I_F = -2.7 \text{ A}, V_{GS} = 0^{\text{Note3}}$ |

Notes: 3. Pulse test

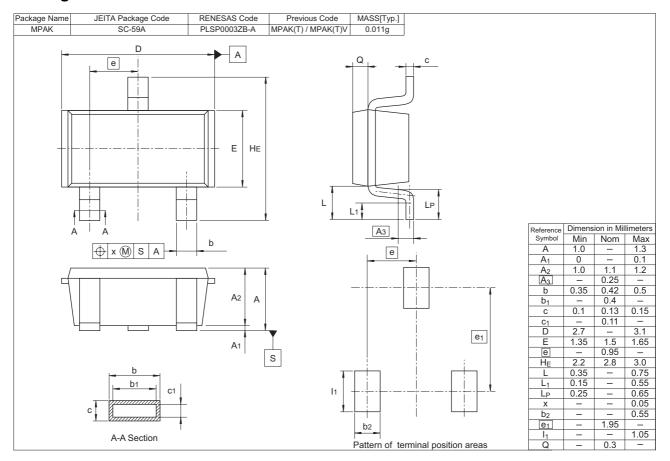
Main Characteristics







Package Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container |
|------------------|-----------|----------------------------------|
| RQJ0202VGDQATL-E | 3000 pcs. | φ178 mm reel, 8 mm Emboss taping |

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